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LISTING OF CLAIMS

- 1. (Canceled)
- 2. (Currently amended) A <u>transistor</u> microdevice for forming a part of an integrated circuit, comprising:
- a first conductive region <u>forming a source</u> and a second conductive region <u>forming a drain</u> having a channel region interposed therebetween; and
- a channel region controlling component <u>forming a gate electrode</u> disposed over the channel region and separated therefrom by at least one dielectric layer, wherein the channel region controlling component has a non-linear structural characteristic derived from a non-linear structural characteristic of a photo resist feature used as an etch mask for the channel region controlling component,

wherein the non-linear characteristic of the photo resist feature <u>is selected to provides</u> mechanical stability to the photo resist feature; <u>and</u>

wherein at any point measured from the source to the drain in a perpendicular direction to a widthwise bisector of the gate electrode, the gate electrode defines a channel length having a substantially constant dimension.

- 3. (Original) The microdevice according to claim 2, wherein the non-linear characteristic of the photo resist feature includes an arc.
- 4. (Original) The microdevice according to claim 2, wherein the non-linear characteristic of the photo resist feature includes a vertex.
- 5. (Currently amended) The microdevice according to claim 2, wherein the non-linear characteristic of the photo resist feature includes a tab extending laterally beyond a width of the photo resist feature <u>and located with respect to the channel region controlling component outside a gate electrode portion thereof.</u>

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(Original) The microdevice according to claim 2, wherein the channel 6. region controlling component is made by deconstructive patterning of one of the photo resist feature or a structure patterned using the photo resist feature.

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7-9. (Canceled)

(Currently amended) The microdevice according to claim 2 [[8]], wherein 10. the generally constant dimension is one of a physical dimension or an electrical dimension.

(Canceled) 11.

(Currently amended) The microdevice according to claim 22 [[11]], 12. wherein the flash memory device is a dielectric charge trapping flash memory device.

13-21. (Canceled)

(New) A flash memory device for forming a part of an integrated circuit, 22. comprising:

a plurality of conductive regions forming bit lines with a channel region interposed between adjacent pairs of bit lines; and

a word line arranged transverse to each bit line and disposed over each channel region to form a control gate therefor, the word line separated from each channel region by at least one dielectric layer and a charge storing layer, wherein the word line has a non-linear structural characteristic derived from a non-linear structural characteristic of a photo resist feature used as an etch mask for the channel region controlling component,

wherein the non-linear characteristic of the photo resist feature is selected to provide mechanical stability to the photo resist feature; and

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wherein the non-linear structural characteristic displaces the word line along a longitudinal axis thereof and each channel has substantially the same channel length as defined by the word line.

- (New) The flash memory device according to claim 22, wherein each 23. channel is defined by a local portion of the word line that has electrical linearity.
- (New) The flash memory device according to claim 22, wherein the non-24. linear structural characteristic of the word line forms a repeating pattern along the longitudinal axis of the of the word line.
- (New) The flash memory device according to claim 22, wherein the non-25. linear characteristic of the photo resist feature includes an arc.
- (New) The flash memory device according to claim 22, wherein the non-26. linear characteristic of the photo resist feature includes a vertex.
- (New) The flash memory device according to claim 22, wherein the non-27. linear characteristic of the photo resist feature includes a tab extending laterally beyond a width of the photo resist feature and located with respect to the word line outside the control gate portions thereof.